

SLOVENSKI STANDARD SIST EN IEC 60691:2024

01-april-2024

Termični taljivi vložki - Zahteve in navodilo za uporabo (IEC 60691:2023)

Thermal-links - Requirements and application guide (IEC 60691:2023)

Temperatursicherungen - Anforderungen und Anwendungshinweise (IEC 60691:2023)

Protecteurs thermiques - Exigences et guide d'application (IEC 60691:2023)

Ta slovenski standard je istoveten z: EN IEC 60691:2023

ICS:

29.120.50 Varovalke in druga is /ed99db6 Fuses and other overcurrent is en-jec-60691-2024

nadtokovna zaščita protection devices

SIST EN IEC 60691:2024 en,fr,de

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EUROPEAN STANDARD NORME EUROPÉENNE FUROPÄISCHE NORM

EN IEC 60691

November 2023

ICS 29.120.50

Supersedes EN 60691:2016; EN 60691:2016/A1:2019

English Version

Thermal-links - Requirements and application guide (IEC 60691:2023)

Protecteurs thermiques - Exigences et guide d'application (IEC 60691:2023)

Temperatursicherungen - Anforderungen und Anwendungshinweise (IEC 60691:2023)

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European Committee for Electrotechnical Standardization Comité Européen de Normalisation Electrotechnique Europäisches Komitee für Elektrotechnische Normung

CEN-CENELEC Management Centre: Rue de la Science 23, B-1040 Brussels

EN IEC 60691:2023 (E)

European foreword

The text of document 32C/604/FDIS, future edition 5 of IEC 60691, prepared by SC 32C "Miniature fuses" of IEC/TC 32 "Fuses" was submitted to the IEC-CENELEC parallel vote and approved by CENELEC as EN IEC 60691:2023.

The following dates are fixed:

- latest date by which the document has to be implemented at national (dop) 2024-07-04
 level by publication of an identical national standard or by endorsement
- latest date by which the national standards conflicting with the (dow) 2026-10-04 document have to be withdrawn

This document supersedes EN 60691:2016 and all of its amendments and corrigenda (if any).

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The text of the International Standard IEC 60691:2023 was approved by CENELEC as a European Standard without any modification.

In the official version, for Bibliography, the following notes have to be added for the standard indicated:

IEC 60085:2007	NOTE	Approved as EN 60085:2008 (not modified)
IEC 60695-10-3:2016 (alog/s	NOTE	Approved as EN 60695-10-3:2016 (not modified)
IEC 60695-11-20:2015	NOTE	Approved as EN 60695-11-20:2015 (not modified)
IEC 60127-1:2006	NOTE	Approved as EN 60127-1:2006 (not modified)
IEC 60127-1:2006/A1:2011	NOTE	Approved as EN 60127-1:2006/A1:2011 (not modified)
IEC 60127-1:2006/A2:2015	NOTE	Approved as EN 60127-1:2006/A2:2015 (not modified)
IEC 60216-1:2013	NOTE	Approved as EN 60216-1:2013 (not modified)
IEC 60695-2-11:2021	NOTE	Approved as EN IEC 60695-2-11:2021 (not modified)

EN IEC 60691:2023 (E)

Annex ZA (normative)

Normative references to international publications with their corresponding European publications

The following documents are referred to in the text in such a way that some or all of their content constitutes requirements of this document. For dated references, only the edition cited applies. For undated references, the latest edition of the referenced document (including any amendments) applies.

NOTE 1 Where an International Publication has been modified by common modifications, indicated by (mod), the relevant EN/HD applies.

NOTE 2 Up-to-date information on the latest versions of the European Standards listed in this annex is available here: www.cencenelec.eu.

<u>Year</u>	<u>Title</u>	EN/HD	<u>Year</u>
2014	Audio, video and similar electronic apparatus - Safety requirements	-	-
2020	Method for the determination of the proof and the comparative tracking indices of solid insulating materials	EN IEC 60112	2020
2014	Miniature fuses - Part 2: Cartridge fuse-links	EN 60127-2	2014
2008	Electrical insulating materials - Thermal endurance properties - Part 5: Determination of relative thermal endurance index (RTE) of an insulating material	EN 60216-5	2008
2020	Insulation coordination for equipment within low-voltage supply systems - Part 1: Principles, requirements and tests	EN IEC 60664-1	2020
2021	Fire hazard testing - Part 2-12: Glowing/hot-wire based test methods - Glow-wire flammability index (GWFI) test method for materials	EN IEC 60695-2-12	2021
2021	Fire hazard testing - Part 2-13: Glowing/hotwire based test methods - Glow-wire ignition temperature (GWIT) test method for materials	EN IEC 60695-2-13	2021
2014	Fire hazard testing - Part 10-2: Abnormal heat - Ball pressure test method	EN 60695-10-2	2014
2013	Fire hazard testing - Part 11-10: Test flames - 50 W horizontal and vertical flame test methods	EN 60695-11-10	2013
2013	Automatic electrical controls - Part 1: General requirements	EN 60730-1	2016
2015		+ A1	2019
2020		+ A2	2022
	2014 2020 2014 2008 2020 2021 2021 2014 2013 2013 2015	Audio, video and similar electronic apparatus - Safety requirements 2020 Method for the determination of the proof and the comparative tracking indices of solid insulating materials 2014 Miniature fuses - Part 2: Cartridge fuse-links 2008 Electrical insulating materials - Thermal endurance properties - Part 5: Determination of relative thermal endurance index (RTE) of an insulating material 2020 Insulation coordination for equipment within low-voltage supply systems - Part 1: Principles, requirements and tests 2021 Fire hazard testing - Part 2-12: Glowing/hot-wire based test methods - Glow-wire flammability index (GWFI) test method for materials 2021 Fire hazard testing - Part 2-13: Glowing/hot-wire based test methods - Glow-wire ignition temperature (GWIT) test method for materials 2021 Fire hazard testing - Part 10-2: Abnormal heat - Ball pressure test method 2013 Fire hazard testing - Part 11-10: Test flames - 50 W horizontal and vertical flame test methods 2013 Automatic electrical controls - Part 1: General requirements	Audio, video and similar electronic apparatus - Safety requirements 2020 Method for the determination of the proof and the comparative tracking indices of solid insulating materials 2014 Miniature fuses - Part 2: Cartridge fuse-links 2018 Electrical insulating materials - Thermal endurance properties - Part 5: Determination of relative thermal endurance index (RTE) of an insulating material 2020 Insulation coordination for equipment within low-voltage supply systems - Part 1: Principles, requirements and tests 2021 Fire hazard testing - Part 2-12: Glowing/hot-wire based test methods - Glow-wire flammability index (GWFI) test method for materials 2021 Fire hazard testing - Part 2-13: Glowing/hot-wire based test methods - Glow-wire ignition temperature (GWIT) test method for materials 2021 Fire hazard testing - Part 10-2: Abnormal EN 60695-2-13 wire based test methods - Glow-wire ignition temperature test method for materials 2031 Fire hazard testing - Part 10-2: Abnormal EN 60695-10-2 heat - Ball pressure test method 2042 Fire hazard testing - Part 11-10: Test flames - 50 W horizontal and vertical flame test methods 2053 Automatic electrical controls - Part 1: EN 60730-1 General requirements 2064 Fire hazard testing - Part 11-10: Test flames - 50 W horizontal and vertical flame test methods

EN IEC 60691:2023 (E)

Publication <u>Year</u> <u>Title</u> EN/HD <u>Year</u> EN 61210 2010

IEC 61210 (mod) 2010 Connecting devices - Flat quick-connect

terminations for electrical copper conductors - Safety requirements



IEC 60691

Edition 5.0 2023-03

INTERNATIONAL STANDARD

NORME INTERNATIONALE

Thermal-links - Requirements and application guide

Protecteurs thermiques - Exigences et guide d'application

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ICS 29.120.50 ISBN 978-2-8322-6469-0

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-2-

CONTENTS

FC	DREWO	RD	5
IN	TRODU	ICTION	7
1	Scop	e	8
2	Norm	native references	8
3	Term	is and definitions	9
4	Gene	eral requirements	11
5		eral notes on tests	
6		sification	
Ü	6.1	Electrical conditions	
	6.2	Thermal conditions	
	6.3	Resistance to tracking	
7		ing	
8		mentation	
9		structional requirements	
	9.1	General	
	9.2	Lead secureness tests	
	9.2.1		
	9.2.2		
	9.2.3	Thrust test	17
	9.2.4	Bending/twist test	17
	9.3	Contacts used for the current path	
	9.4	Accessible mounting brackets or metal parts	19
	9.5	Insulating materials	
	9.6	Resistance to tracking	
	9.7	Creepage distances and clearances	
	9.8	Temperature and humidity cycle conditioning	
10	9.9		20
10		rical requirements	
	10.1 10.2	Dielectric strength	
	10.2	Insulation resistance	
	10.3	, -	
	10.3.		
	10.4	Transient overload current	
	10.5	Limited short-circuit test	
	10.5.	1 General	24
	10.5.	2 Test method	24
	10.5.	3 Fuse size (rating)	25
	10.5.	4 Compliance	25
11	Temp	perature tests	25
	11.1	General	25
	11.2	Holding temperature, T_h	26
	11.3	Rated functioning temperature, Tf	26
	11.4	Maximum temperature limit, T_{m}	26
	11.5	Ageing	27

Annex A (normative) Application guide	12 Resistance to rusting	27
Annex B (normative) Alternative ageing test for thermal-links with T _h greater than 250 °C for use in electric irons	13 Manufacturer's validation programme	28
250 °C for use in electric irons	Annex A (normative) Application guide	29
Annex C (normative) Conductive heat ageing test	Annex B (normative) Alternative ageing test for thermal-links with T_h greater than	
C.1 Conductive heat ageing test 31 C.2 Method 31 C.2.1 General 31 C.2.2 Typical test fixture assembly 31 C.2.3 Temperature betting 31 C.2.4 Temperature behaviour 31 C.2.5 Temperature monitoring 32 C.3 Ageing 32 C.3.1 General 32 C.3.2 Cooling operation 32 C.3.3 Premature operation 32 C.4 Results 33 C.5 Dielectric strength test 33 C.6 Test oven 33 Anex D (informative) Extended holding temperature evaluation 35 D.1 Extended holding temperature evaluation 35 D.1 Extended holding temperature evaluation 35 D.2 Load current interrupt test 35 Annex F (normative) Beal ageing test 37 Annex F (normative) Identification requirements 39 Annex F (normative) Identification requirements 30 Annex F (normative) Requirements for thermal-lin	250 °C for use in electric irons	30
C.2 Method 31 C.2.1 General 31 C.2.2 Typical test fixture assembly 31 C.2.3 Temperature setting 31 C.2.4 Temperature behaviour 31 C.2.5 Temperature monitoring 32 C.3 Ageing 32 C.3.1 General 32 C.3.2 Cooling operation 32 C.3.3 Premature operation 32 C.4 Results 33 C.5 Dielectric strength test 33 C.6 Test oven 33 Annex D (informative) Extended holding temperature evaluation 35 D.1 Extended holding temperature conditioning test 35 D.2 Load current interrupt test 35 Annex E (normative) Seal ageing test 37 Annex E (normative) Identification requirements 39 Annex F (normative) Indelibility of markings 40 Annex I (informative) Requirements for thermal-link packaged assemblies 41 Annex I (informative) Holding temperature 45 Bibliography 46 Figure 1 – Bending/twist test 18 Figure C.1 – Typical terminal block support test fixture 36 Figu	Annex C (normative) Conductive heat ageing test	31
C.2.1 General 31 C.2.2 Typical test fixture assembly 31 C.2.3 Temperature setting 31 C.2.4 Temperature behaviour 31 C.2.5 Temperature monitoring 32 C.3 Ageing 32 C.3.1 General 32 C.3.2 Cooling operation 32 C.3.3 Premature operation 32 C.5 Dielectric strength test 33 C.6 Test oven 33 Annex D (informative) Extended holding temperature evaluation 35 D.1 Extended holding temperature conditioning test 35 D.2 Load current interrupt test 35 Annex E (normative) Seal ageing test 37 Annex F (normative) Identification requirements 39 Annex H (normative) Requirements for thermal-link packaged assemblies 41 Annex I (informative) Holding temperature 45 Bibliography 46 Figure 1 – Bending/twist test 18 Figure C.1 – Typical test fixture assembly 33 Figure E.1 – Conditioning time versus oven temperature for proposed temperature index 38 Figure E.1 – Conditioning time versus oven temperature for proposed temperature index 38 <td>C.1 Conductive heat ageing test</td> <td>31</td>	C.1 Conductive heat ageing test	31
C.2.2 Typical test fixture assembly 31 C.2.3 Temperature setting 31 C.2.4 Temperature behaviour 31 C.2.5 Temperature monitoring 32 C.3 Ageing 32 C.3.1 General 32 C.3.2 Cooling operation 32 C.3.3 Premature operation 32 C.4 Results 33 C.5 Dielectric strength test 33 C.6 Test oven 33 Annex D (informative) Extended holding temperature evaluation 35 D.1 Extended holding temperature conditioning test 35 D.2 Load current interrupt test 35 Annex E (normative) Seal ageing test 37 Annex F (normative) Identification requirements 39 Annex F (normative) Identification requirements 39 Annex I (informative) Hodilibility of markings 40 Annex I (informative) Holding temperature 45 Bibliography 46 Figure C.1 – Typical test fixture assembly 33<	C.2 Method	31
C.2.3 Temperature behaviour. 31 C.2.5 Temperature behaviour. 31 C.2.5 Temperature monitoring. 32 C.3 Ageing. 32 C.3.1 General. 32 C.3.2 Cooling operation. 32 C.3.3 Premature operation. 32 C.4 Results. 33 C.5 Dielectric strength test. 33 C.6 Test oven. 33 Annex D (informative) Extended holding temperature evaluation. 35 D.1 Extended holding temperature conditioning test. 35 D.2 Load current interrupt test. 35 Annex E (normative) Seal ageing test. 37 Annex E (normative) Identification requirements 39 Annex H (normative) Indelibility of markings. 40 Annex I (informative) Requirements for thermal-link packaged assemblies. 41 Annex I (informative) Holding temperature. 45 Bibliography. 46 Figure 1 – Bending/twist test. 18 Figure C.1 – Typical test fixture assembly. 36 Figure E.1 – Conditioning time ve		
C.2.4 Temperature behaviour 31 C.2.5 Temperature monitoring 32 C.3.4 General 32 C.3.2 Cooling operation 32 C.3.3 Premature operation 32 C.4 Results 33 C.5 Dielectric strength test 33 C.6 Test oven 33 Annex D (informative) Extended holding temperature evaluation 35 D.1 Extended holding temperature conditioning test 35 D.2 Load current interrupt test 35 Annex E (normative) Seal ageing test 35 Annex F (normative) Identification requirements 39 Annex G (normative) Identification requirements 39 Annex I (informative) Requirements for thermal-link packaged assemblies 41 Annex I (informative) Holding temperature 45 Bibliography 46 Figure 1 – Bending/twist test 18 Figure C.1 – Typical terminal block support test fixture 36 Figure E.1 – Conditioning time versus oven temperature for proposed temperature index 38	· · · · · · · · · · · · · · · · · · ·	
C.2.5 Temperature monitoring 32 C.3 Ageing 32 C.3.1 General 32 C.3.2 Cooling operation 32 C.3.3 Premature operation 32 C.4 Results 33 C.5 Dielectric strength test 33 C.6 Test oven 33 Annex D (informative) Extended holding temperature evaluation 35 D.1 Extended holding temperature conditioning test 35 D.2 Load current interrupt test 35 Annex E (normative) Seal ageing test 37 Annex F (normative) Identification requirements 39 Annex F (normative) Indelibility of markings 40 Annex I (informative) Requirements for thermal-link packaged assemblies 41 Annex I (informative) Holding temperature 45 Bibliography. 46 Figure 1 – Bending/twist test 18 Figure 2.1 – Typical test fixture assembly 33 Figure B.1 – Conditioning time versus oven temperature for proposed temperature index 36 Figure E.1 – Conditioning time versus oven temperature for proposed temperature index 38<	·	
C.3 Ageing 32 C.3.1 General 32 C.3.2 Cooling operation 32 C.3.3 Premature operation 32 C.4 Results 33 C.5 Dielectric strength test 33 C.6 Test oven 33 Annex D (informative) Extended holding temperature evaluation 35 D.1 Extended holding temperature conditioning test 35 D.2 Load current interrupt test 35 Annex E (normative) Seal ageing test 37 Annex F (normative) Identification requirements 39 Annex F (normative) Indelibility of markings 40 Annex H (normative) Requirements for thermal-link packaged assemblies 41 Annex I (informative) Holding temperature 45 Bibliography 46 Figure 1 – Bending/twist test 18 Figure C.1 – Typical test fixture assembly 33 Figure E.1 – Conditioning time versus oven temperature for proposed temperature index 36 Figure E.1 – Conditioning time versus oven temperature for proposed temperature index 36	•	
C.3.1 General 32 C.3.2 Cooling operation 32 C.3.3 Premature operation 32 C.4 Results 33 C.5 Dielectric strength test 33 C.6 Test oven 33 Annex D (informative) Extended holding temperature evaluation 35 D.1 Extended holding temperature conditioning test 35 D.2 Load current interrupt test 35 Annex E (normative) Seal ageing test 37 Annex F (normative) Identification requirements 39 Annex G (normative) Indelibility of markings 40 Annex I (informative) Requirements for thermal-link packaged assemblies 41 Annex I (informative) Holding temperature 45 Bibliography 46 Figure 1 – Bending/twist test 18 Figure C.1 – Typical test fixture assembly 33 Figure C.2 – Typical thermal-link test oven 34 Figure E.1 – Conditioning time versus oven temperature for proposed temperature index 38 Figure E.1 – Apparatus for testing durability of markings 40	, ,	
C.3.2 Cooling operation		
C.3.3 Premature operation		
C.4 Results	5 1	
C.5 Dielectric strength test	•	
C.6 Test oven		
D.1 Extended holding temperature conditioning test		
D.2 Load current interrupt test	Annex D (informative) Extended holding temperature evaluation	35
Annex E (normative) Seal ageing test	D.1 Extended holding temperature conditioning test	35
Annex F (normative) Identification requirements	D.2 Load current interrupt test	35
Annex G (normative) Indelibility of markings	Annex E (normative) Seal ageing test	37
Annex H (normative) Requirements for thermal-link packaged assemblies		
Annex I (informative) Holding temperature	Annex G (normative) Indelibility of markings	40
Figure 1 – Bending/twist test		
Figure 1 – Bending/twist test	Annex I (informative) Holding temperature	45
Figure 1 – Bending/twist test	://standards.iteh.ai/cátalog/staĭidards/sist/cd99db66-8fff-4cde-a2dc-31dcceff9faf/sist-en-ic Bibliography	46
Figure C.1 – Typical test fixture assembly		
Figure C.1 – Typical test fixture assembly	Figure 1 – Bending/twist test	18
Figure C.2 – Typical thermal-link test oven		
Figure D.1 – Typical terminal block support test fixture	·	
Figure E.1 – Conditioning time versus oven temperature for proposed temperature index38 Figure G.1 – Apparatus for testing durability of markings		
Figure G.1 – Apparatus for testing durability of markings		
Table 1 – Test schedule		
Table 2 – Strength of leads and terminal parts – Minimum required tensile and thrust test forces	Figure G. 1 – Apparatus for testing durability of markings	40
Table 2 – Strength of leads and terminal parts – Minimum required tensile and thrust test forces	Table 1 – Test schedule	13
test forces		
Table 4 – Test voltages for dielectric strength		18
Table 5 – Test current for interrupting test	Table 3 – Creepage distances and clearances (absolute minimum values)	20
Table 6 – Limited short-circuit test capacity	Table 4 – Test voltages for dielectric strength	21
Table 6 – Limited short-circuit test capacity	Table 5 – Test current for interrupting test	22
· · · ·	Table 6 – Limited short-circuit test capacity	24

4 –	IEC 60691:2023 © IEC 2	2023
-----	------------------------	------

Table H.2 –	Minimum nominal	cross-sectional	area of conductor		43
Table H.3 -	Allowed values for	r the materials us	sed in the thermal	I-link package	44

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INTERNATIONAL ELECTROTECHNICAL COMMISSION

THERMAL-LINKS – REQUIREMENTS AND APPLICATION GUIDE

FOREWORD

- 1) The International Electrotechnical Commission (IEC) is a worldwide organization for standardization comprising all national electrotechnical committees (IEC National Committees). The object of IEC is to promote international co-operation on all questions concerning standardization in the electrical and electronic fields. To this end and in addition to other activities, IEC publishes International Standards, Technical Specifications, Technical Reports, Publicly Available Specifications (PAS) and Guides (hereafter referred to as "IEC Publication(s)"). Their preparation is entrusted to technical committees; any IEC National Committee interested in the subject dealt with may participate in this preparatory work. International, governmental and non-governmental organizations liaising with the IEC also participate in this preparation. IEC collaborates closely with the International Organization for Standardization (ISO) in accordance with conditions determined by agreement between the two organizations.
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- Attention is drawn to the Normative references cited in this publication. Use of the referenced publications is 91-2024 indispensable for the correct application of this publication.
 - 9) Attention is drawn to the possibility that some of the elements of this IEC Publication may be the subject of patent rights. IEC shall not be held responsible for identifying any or all such patent rights.

IEC 60691 has been prepared by subcommittee 32C: Miniature fuses, of IEC technical committee 32: Fuses. It is an International Standard.

This fifth edition cancels and replaces the fourth edition published in 2015 and Amendment 1:2019. This edition constitutes a technical revision.

This fifth edition includes the following significant technical changes with respect to the previous edition:

- a) requirements for thermal-link packaged assemblies;
- b) renew the requirements and definitions for T_h -test;

The harmonization of the USA national standard, UL 1020, fifth edition (withdrawn 2003), and IEC 60691:1993, together with its Amendment 1:1995 and Amendment 2:2000 have served as a basis for the elaboration of this standard.

The text of this International Standard is based on the following documents:

Draft	Report on voting	
32C/604/FDIS	32C/605/RVD	

- 6 -

Full information on the voting for its approval can be found in the report on voting indicated in the above table.

The language used for the development of this International Standard is English.

This document was drafted in accordance with ISO/IEC Directives, Part 2, and developed in accordance with ISO/IEC Directives, Part 1 and ISO/IEC Directives, IEC Supplement, available at www.iec.ch/members_experts/refdocs. The main document types developed by IEC are described in greater detail at www.iec.ch/publications.

The following differing practices of a less permanent nature exist in the country indicated below:

- Annex C is required to be declared in the USA;
- Annex E is required in the USA, if applicable;
- Annex F is required to be declared in the USA.

In this standard, the following type is used:

compliance statements: in italic type.

The committee has decided that the contents of this document will remain unchanged until the stability date indicated on the IEC website under webstore.iec.ch in the data related to the specific document. At this date, the document will be

- · reconfirmed,
- withdrawn,
- replaced by a revised edition, or
- amended.

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– 7 –

INTRODUCTION

Thermal-links, defined as non-resettable devices functioning once only without refunctioning, are widely applied for the thermal protection of equipment in which, under fault (abnormal) conditions, one or more parts may reach hazardous temperatures.

As these devices have several aspects in common with miniature fuse-links and are used for obtaining a comparable degree of protection, this standard has endeavoured to lay down a number of basic requirements for such devices.

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THERMAL-LINKS – REQUIREMENTS AND APPLICATION GUIDE

- 8 -

1 Scope

This International Standard is applicable to thermal-links intended for incorporation in electrical appliances, electronic equipment and component parts thereof, normally intended for use indoors, in order to protect them against excessive temperatures under abnormal conditions.

NOTE 1 The equipment is not designed to generate heat.

NOTE 2 The effectiveness of the protection against excessive temperatures logically depends upon the position and method of mounting of the thermal-link, as well as upon the current which it is carrying.

This document may be applicable to thermal-links for use under conditions other than indoors, provided that the climatic and other circumstances in the immediate surroundings of such thermal-links are comparable with those in this standard.

This document may be applicable to thermal-links in their simplest forms (e.g. melting strips or wires), provided that molten materials expelled during function cannot adversely interfere with the safe use of the equipment, especially in the case of hand-held or portable equipment, irrespective of its position.

Annex H of this document is applicable to thermal-link packaged assemblies where the thermal-link(s) has already been approved to this standard but packaged in a metallic or non-metallic housing and provided with terminals/wiring leads.

This document is applicable to thermal-links with a rated voltage not exceeding 690 V AC or DC and a rated current not exceeding 63 A.

The objectives of this document are: SIST EN IEC 60691:2024

- a) to establish uniform requirements for thermal-links,
- b) to define methods of test, and
- c) to provide useful information for the application of thermal-links in equipment.

This document is not applicable to thermal-links used under extreme conditions such as corrosive or explosive atmospheres.

This document is not applicable to thermal-links to be used in circuits on AC with a frequency lower than 45 Hz or higher than 62 Hz.

2 Normative references

The following documents are referred to in the text in such a way that some or all of their content constitutes requirements of this document. For dated references, only the edition cited applies. For undated references, the latest edition of the referenced document (including any amendments) applies.

IEC 60065:2014, Audio, video and similar electronic apparatus – Safety requirements

IEC 60112:2020, Method for the determination of the proof and the comparative tracking indices of solid insulating materials